

<p><b>XXW160N06</b></p> <p>60V N-Channel MOSFET</p> <p><b>Features:</b></p> <ul style="list-style-type: none"> <li><input type="checkbox"/> Low Intrinsic Capacitances.</li> <li><input type="checkbox"/> Excellent Switching Characteristics.</li> <li><input type="checkbox"/> Extended Safe Operating Area.</li> <li><input type="checkbox"/> Unrivalled Gate Charge :<math>Q_g = 152\text{nC}</math> (Typ.).</li> <li><input type="checkbox"/> <math>\text{BV}_{\text{DSS}}=60\text{V}, I_{\text{D}}=160\text{A}</math></li> <li><input type="checkbox"/> <math>R_{\text{DS}(\text{on})} : 4.0\text{m}\Omega</math> (Max) @ <math>V_{\text{G}}=10\text{V}</math></li> <li><input type="checkbox"/> 100% Avalanche Tested</li> </ul>	<p style="text-align: center;"><b>TO-220</b></p> <p style="text-align: center;"> <b>1. Gate (G)</b>  <b>2. Drain (D)</b>  <b>3. Source (S)</b> </p>
-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------	-------------------------------------------------------------------------------------------------------------------------------------------------------------

### Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Maximum	Unit
$V_{\text{DSS}}$	Drain-to-Source Voltage	60	V
$V_{\text{GSS}}$	Gate-to-Source Voltage	$\pm 20$	V
$I_{\text{D}}^3$	Continuous Drain Current	$T_C=25^\circ\text{C}$	160
		$T_C=100^\circ\text{C}$	105
$I_{\text{DP}}^4$	Pulsed Drain Current	$T_C=25^\circ\text{C}$	600
$I_{\text{AS}}^5$	Avalanche Current	28	mJ
$E_{\text{AS}}^5$	Avalanche energy	900	
PD	Maximum Power Dissipation	$T_C=25^\circ\text{C}$	200
		$T_C=100^\circ\text{C}$	92.5
$T_J, T_{\text{STG}}$	Junction & Storage Temperature Range	-55~175	$^\circ\text{C}$

### Thermal Characteristics

Symbol	Parameter	Typical	Unit
$R_{\theta\text{jc}}$	Thermal Resistance-Junction to Case	0.68	$^\circ\text{C/W}$
$R_{\theta\text{ja}}$	Thermal Resistance-Junction to Ambient	62.5	

**Electrical Characteristics** (TA=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ	Max.	Unit
<b>Static Characteristics</b>						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	60	—	—	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V	—	—	1	uA
		T <sub>J</sub> =125°C	—	—	100	
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA	2	3	4	V
I <sub>GSS</sub>	Gate Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	—	—	±100	nA
R <sub>DS(on)</sub> <sup>1</sup>	Drain-Source On-Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =80A	—	2.9	4.0	mΩ
		—	—	—	—	
<b>Diode Characteristics</b>						
V <sub>SD</sub> <sup>1</sup>	Diode Forward Voltage	I <sub>SD</sub> =80A, V <sub>GS</sub> =0V	—	0.88	1.2	V
I <sub>s</sub> <sup>3</sup>	Diode Continuous Forward Current	—	—	—	160	A
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> =80A, T <sub>J</sub> =25°C	—	73	—	nS
Q <sub>rr</sub>	Reverse Recovery Charge		—	98	—	nC
<b>Dynamic Characteristics</b> <sup>2</sup>						
R <sub>G</sub>	Gate Resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, Frequency=1MHz	—	0.7	—	Ω
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =30V Frequency=1MHz	—	7820	—	pF
C <sub>oss</sub>	Output Capacitance		—	634	—	
C <sub>rss</sub>	Reverse Transfer Capacitance		—	502	—	
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> =30V, RL=0.4Ω V <sub>GS</sub> =10V, R <sub>G</sub> =2.5Ω	—	31	—	nS
t <sub>r</sub>	Rise Time		—	29	—	
t <sub>d(off)</sub>	Turn-Off Delay Time		—	110	—	
t <sub>f</sub>	Fall Time		—	46	—	
<b>Gate Charge Characteristics</b> <sup>2</sup>						
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =30V, V <sub>GS</sub> =10V I <sub>D</sub> =160A	—	152	—	nC
Q <sub>qs</sub>	Gate-to-Source Charge		—	33	—	
Q <sub>qd</sub>	Gate-to-Drain Charge		—	55	—	

Note: 1: Pulse test; pulse width  $\leq$  300us, duty cycle  $\leq$  2%.

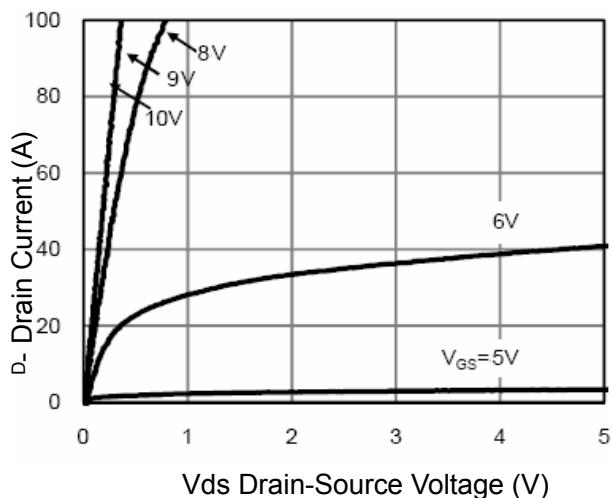
2: Guaranteed by design, not subject to production testing.

3: Package limitation current is 75A.Calculated continuous current based on maximum allowable junction temperature.

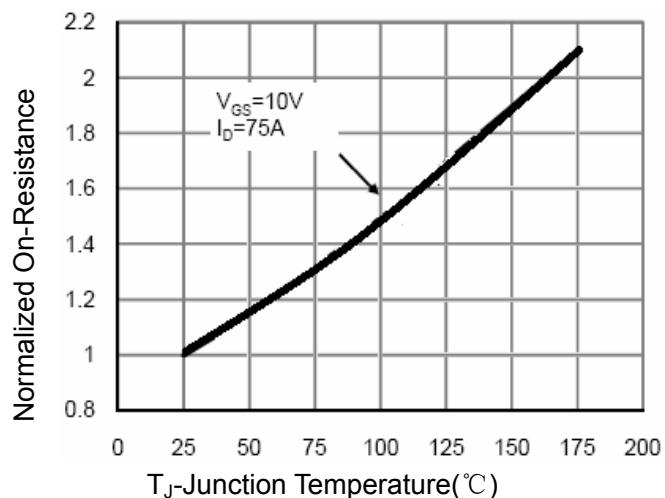
4: Repetitive rating, pulse width limited by max junction temperature.

5: Starting TJ = 25°C,L = 0.5mH

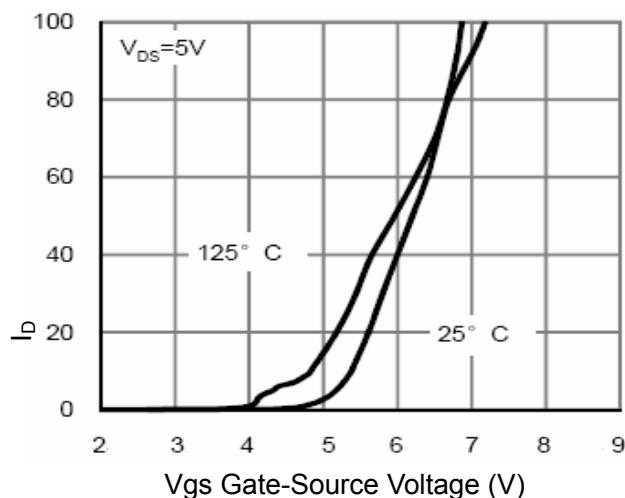
### Typical Characteristics



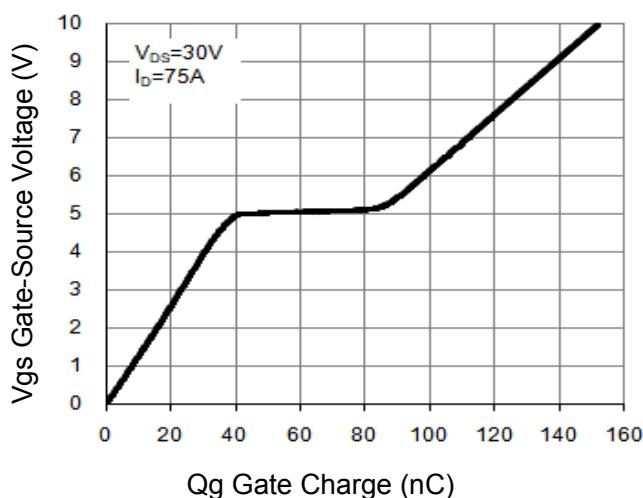
**Figure 1 Output Characteristics**



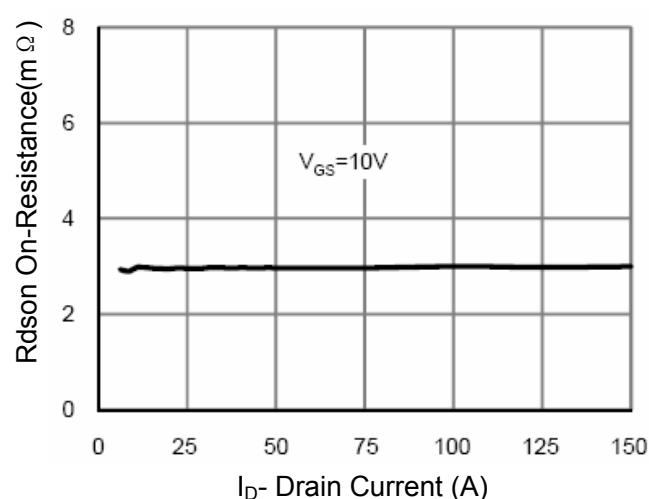
**Figure 4 Rdson-JunctionTemperature**



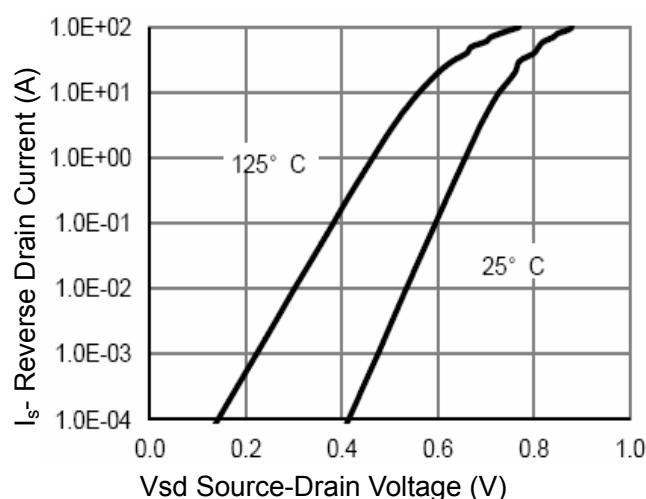
**Figure 2 Transfer Characteristics**



**Figure 5 Gate Charge**

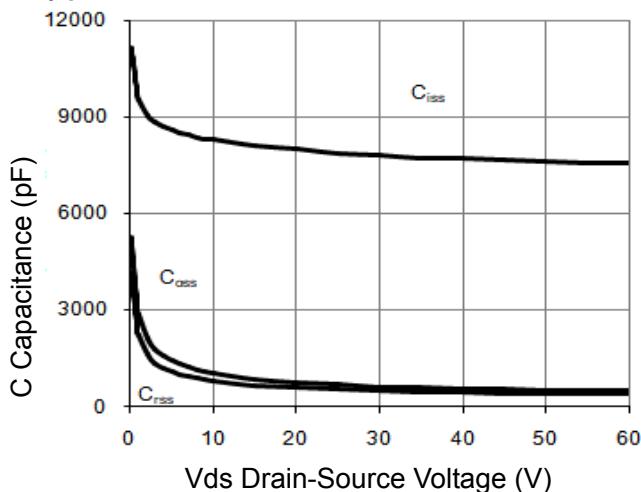


**Figure 3 Rdson- Drain Current**

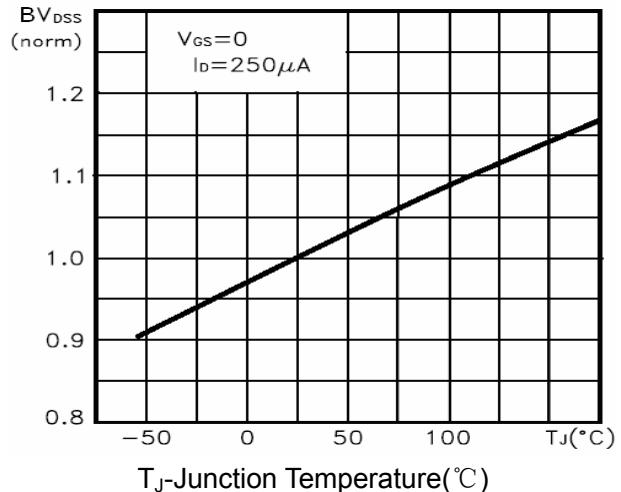


**Figure 6 Source- Drain Diode Forward**

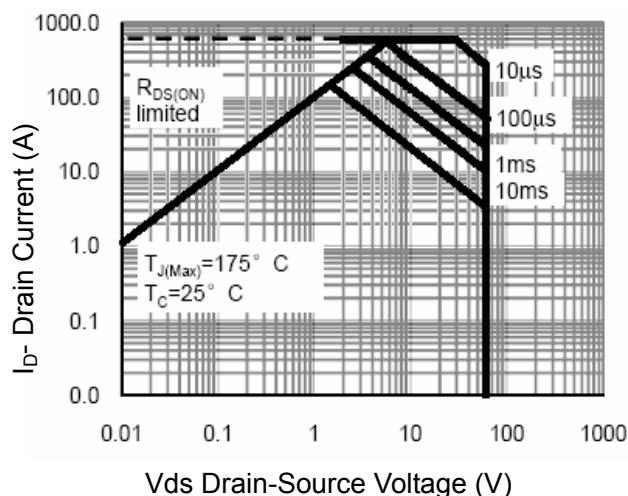
### Typical Characteristics



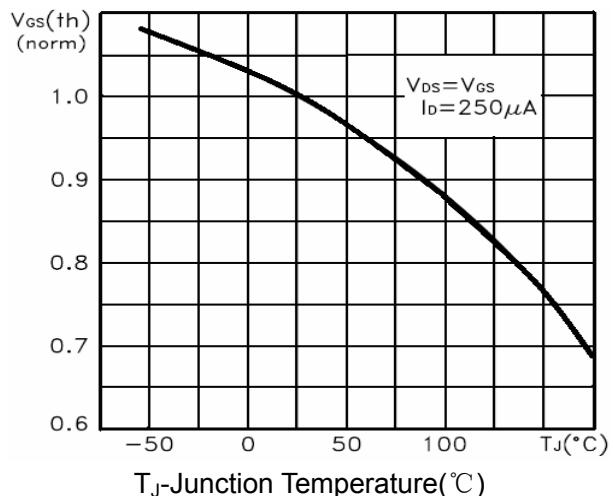
**Figure 7 Capacitance vs Vds**



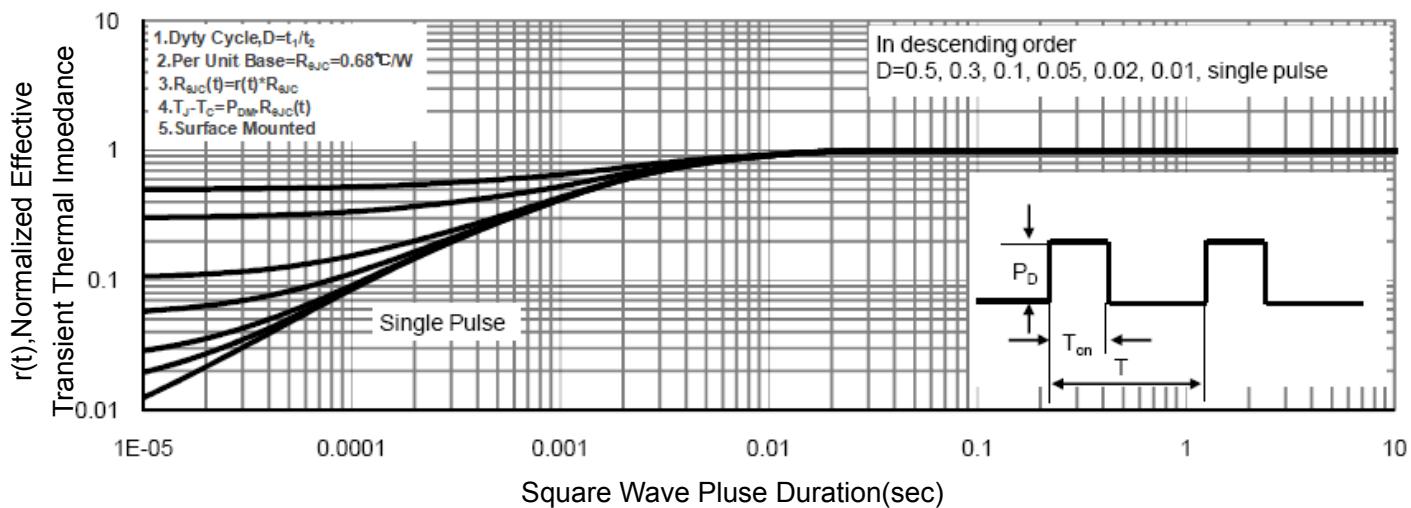
**Figure 9  $BV_{dss}$  vs Junction Temperature**



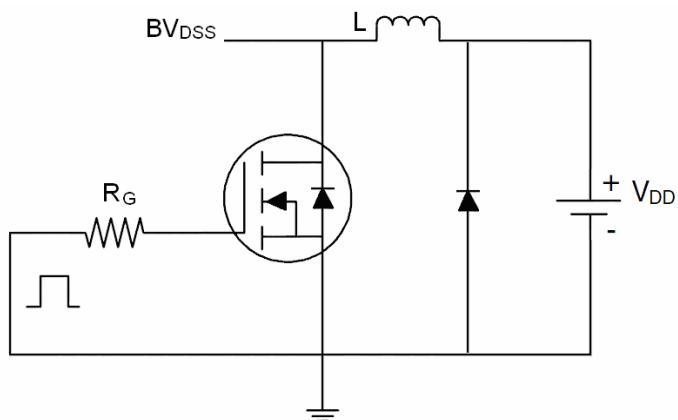
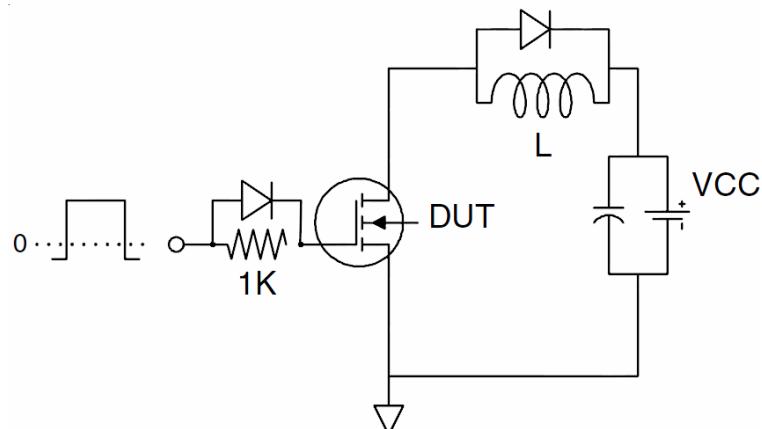
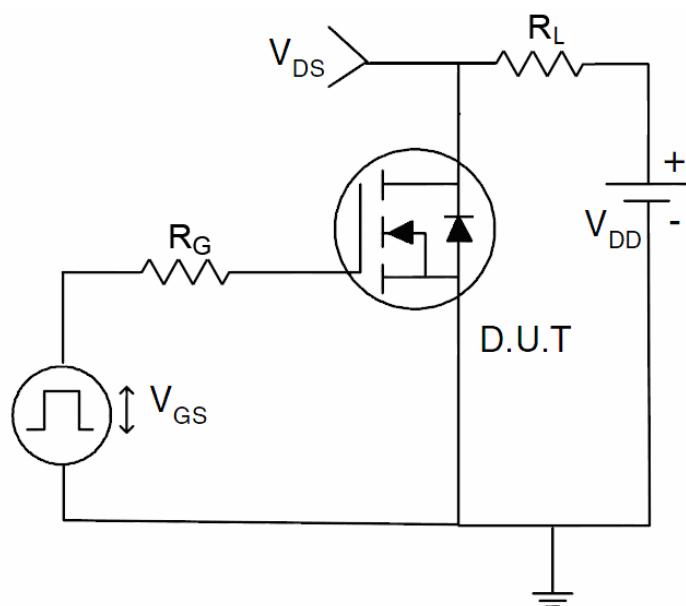
**Figure 8 Safe Operation Area**



**Figure 10  $V_{GS(\text{th})}$  vs Junction Temperature**



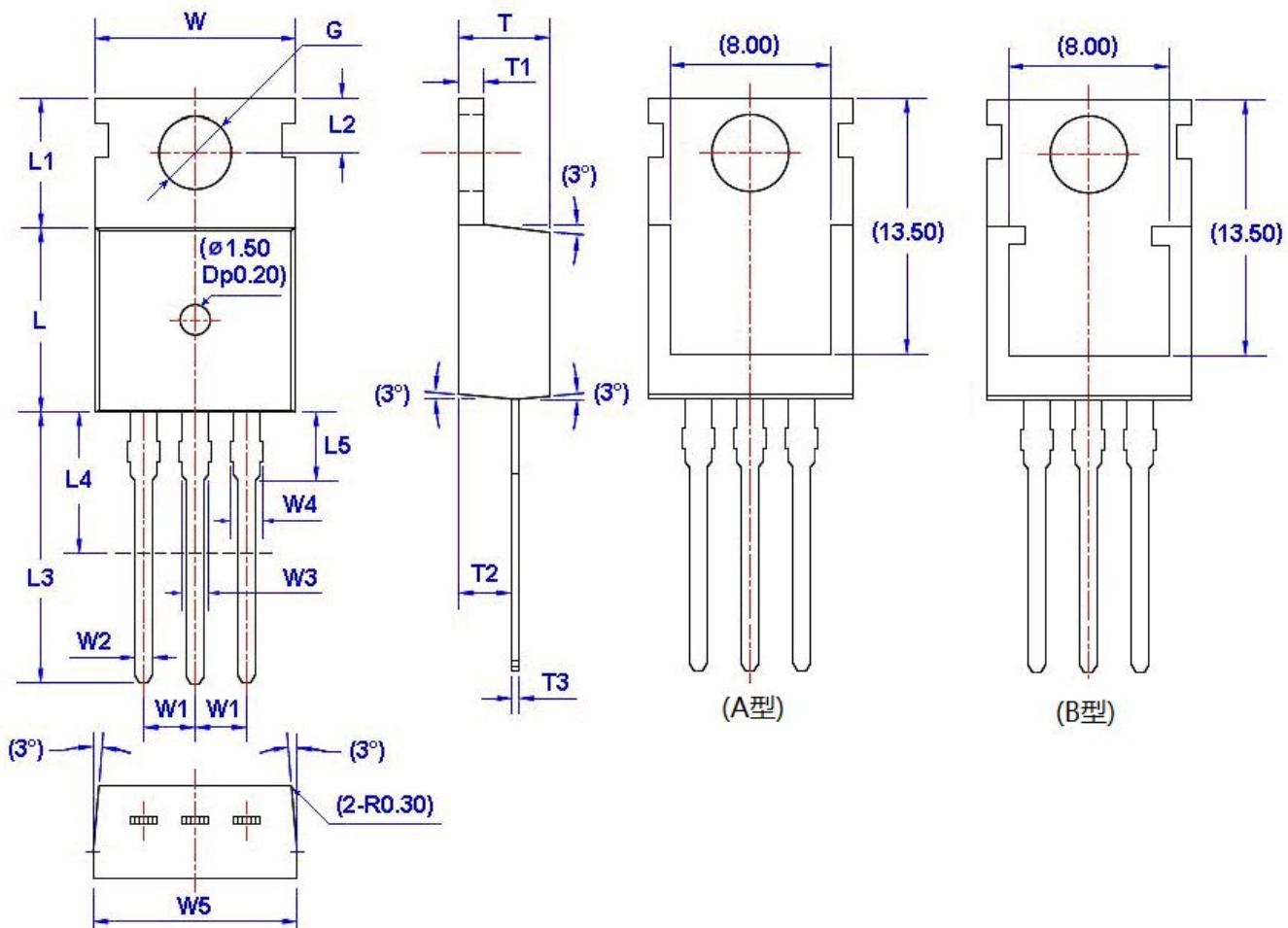
**Figure 11 Normalized Maximum Transient Thermal Impedance**

**Test circuit**
**1) E<sub>AS</sub> test Circuits**

**2) Gate charge test Circuit:**

**3) Switch Time Test Circuit:**


## Package Dimension

TO-220

Unit:mm



Symbol	Size		Symbol	Size		Symbol	Size		Symbol	Size	
	Min	Max		Min	Max		Min	Max		Min	Max
W	9.66	10.28	W5	9.80	10.20	L4**	6.20	6.60	T3	0.45	0.60
W1	2.54 (TYP)		L	9.00	9.40	L5	2.79	3.30	G(Φ)	3.50	3.70
W2	0.70	0.95	L1	6.40	6.80	T	4.30	4.70			
W3	1.17	1.37	L2	2.70	2.90	T1	1.15	1.40			
W4*	1.32	1.72	L3	12.70	14.27	T2	2.20	2.60			